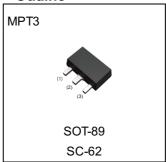


#### Midium Power Transistors (-30V / -5V)

Parameter	Value
$V_{CEO}$	-30V
IC	-5A

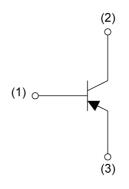
#### Outline



#### Features

1)Low saturation voltage, typically  $V_{CE(sat)}$  =-0.4V (Max.) ( $I_C/I_B$ =-2A/-100mA)
2)High speed switching

#### Inner circuit



- (1) Base
- (2) Collector
- (3) Emitter

### Application

LOW FREQUENCY AMPLIFIER, HIGH SPEED SWITCHING

### Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SAR542P	MPT3	4540	T100	180	12	1000	MQ

## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	$V_{CBO}$	-30	V
Collector-emitter voltage	V <sub>CEO</sub>	-30	V
Emitter-base voltage	V <sub>EBO</sub>	-6	V
Collector current	Ic	-5	Α
Collector current	I <sub>CP</sub> *1	-10	Α
Dower discination	P <sub>D</sub> *2	0.5	W
Power dissipation	P <sub>D</sub> *3	2.0	W
Junction temperature	T <sub>j</sub>	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

# • Electrical characteristics $(T_a = 25^{\circ}C)$

Darameter	Symbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = -100μA	-30	-	-	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = -1mA	-30	-	-	V
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = -100μA	-6	-	-	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = -30V	-	1	-1.0	μA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = -4V	-	1	-1.0	μA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub> *4	$I_C = -2A$ , $I_B = -100mA$	-	-200	-400	mV
DC current gain	h <sub>FE</sub>	$V_{CE} = -2V, I_{C} = -500 \text{mA}$	200	-	500	-
Transition frequency	f <sub>T</sub> *4	$V_{CE} = -10V, I_{E} = 100mA,$ f = 100MHz	-	240	-	MHz
Output capacitance	C <sub>ob</sub>	$V_{CB} = -10V, I_{E} = 0A,$ f = 1MHz	-	40	-	pF
Turn-On time	t <sub>on</sub>	I <sub>C</sub> = -2.5A, I <sub>B1</sub> = -250mA,	-	45	-	ns
Storage time	t <sub>stg</sub>	$I_{B2} = 250 \text{mA},$ $V_{CC} \simeq -10 \text{V},$	-	200	-	ns
Fall time	t <sub>f</sub>	$R_L = 3.9\Omega$ See test circuit	-	25	-	ns

<sup>\*1</sup> Pw=10ms, Single pulse

<sup>\*2</sup> Each terminal mounted on a reference land.

<sup>\*3</sup> Mounted on a ceramic board.(40×40×0.7mm)

<sup>\*4</sup> Plused

## ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.1 Ground Emitter Propagation Characteristics

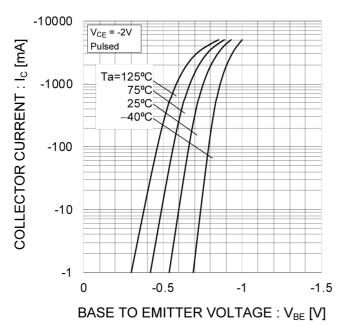
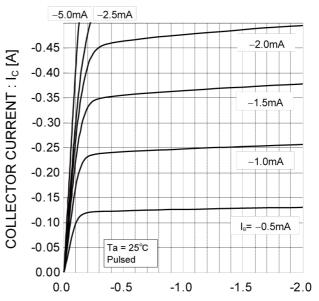


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V<sub>CE</sub> [V]

Fig.3 DC Current Gain vs. Collector Current (I)

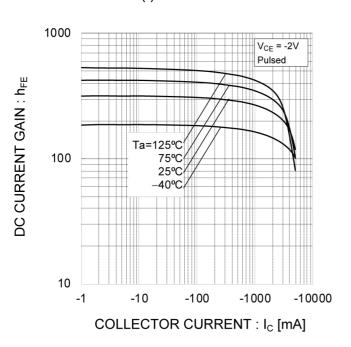
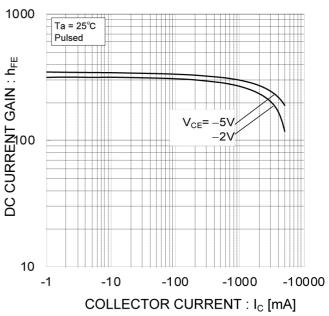


Fig.4 DC Current Gain vs. Collector Current (II)



### ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current (I)

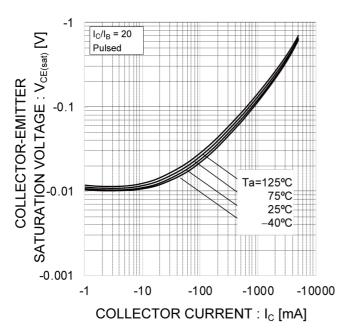


Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current (II)

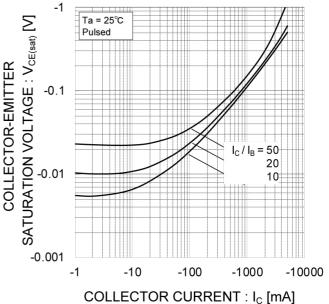


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

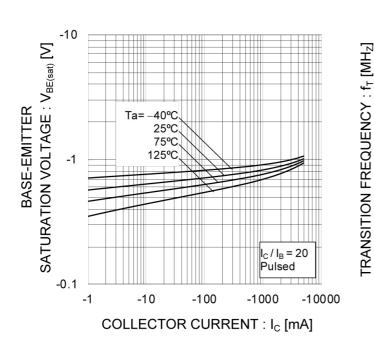
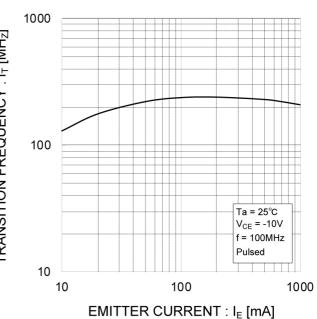


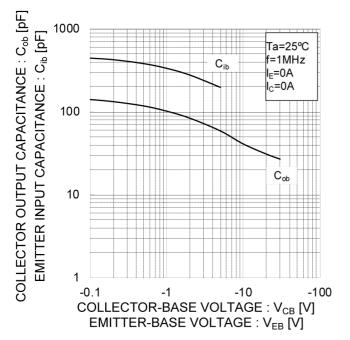
Fig.8 Gain Bandwidth Product vs. Emitter Current

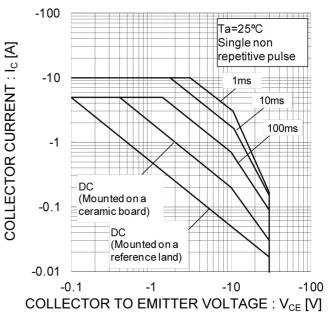


### ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

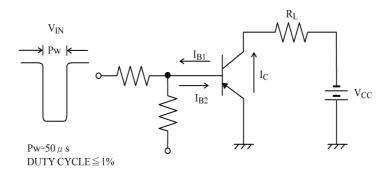
Fig.9 Emitter Input Capacitance vs.
Emitter-Base Voltage
Collector Output Capacitance vs.
Collector-Base Voltage

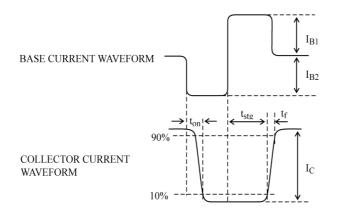
Fig.10 Safe Operating Area



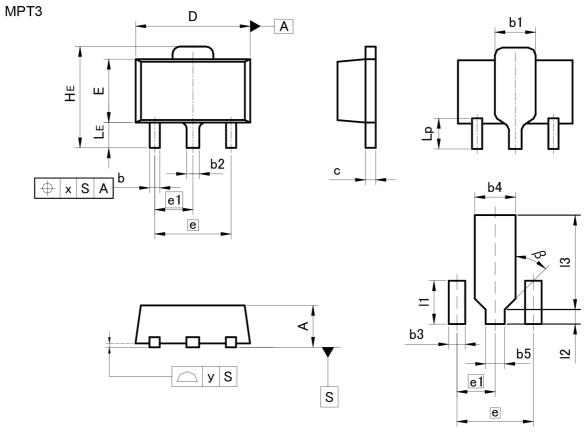


#### SWITCHING TIME TEST CIRCUIT





### Dimensions



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	1.40	1.50	0.055	0.059	
b	0.30	0.50	0.012	0.020	
b1	1.50	1.70	0.059	0.067	
b2	0.40	0.60	0.016	0.024	
С	0.35	0.50	0.014	0.020	
D	4.40	4.70	0.173	0.185	
E	2.40	2.70	0.094	0.106	
е	3.00		0.118		
e1	1.50		0.059		
HE	3.70	4.30	0.146	0.169	
LE	0.80	1.20	0.031	0.047	
Lp	1.01	1.41	0.040	0.056	
x	-	0.15	- 0.006		
У	_	0.10	-	0.004	

DIM	MILIM	ETERS	INCHES		
	MIN	MAX	MIN	MAX	
b3	_	0.65	ı	0.026	
b4	_	1.70	ı	0.067	
b5	_	0.75	-	0.030	
l1	_	1.71	ı	0.067	
12	_	0.58	ı	0.023	
13	_	3.72	-	0.146	
β	45	0	45	0	

Dimension in mm/inches



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